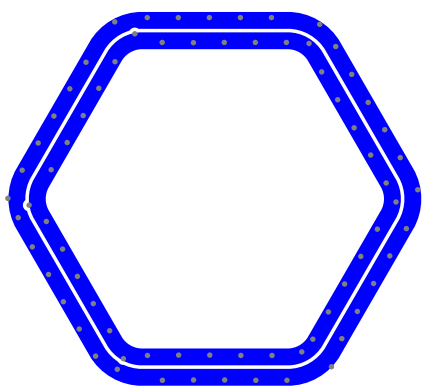
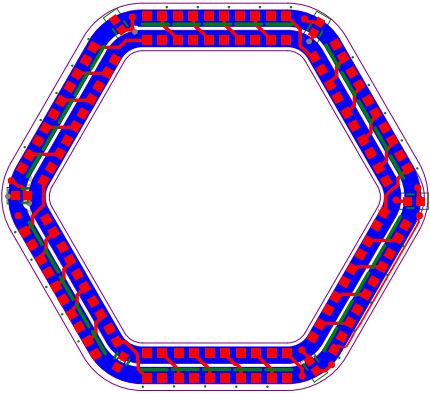


Top Layer



Bottom

Layer	Name	Material	Thickness	Constant	Board Layer Stack
	Top Overlay				
	Top Solder	SM-002	0.025mm	4	
	Top Surface Finish	Nickel, Gold	0.005mm		
1	Top Layer	CF-004	0.035mm		
	Adhesive 2	PP-006	0.015mm	4.1	
	PI 1	Composite dielectric	0.025mm	4.1	
	Adhesive 1	PP-006	0.015mm	4.1	
2	Bottom Layer	CF-004	0.035mm		
	Bottom Surface Finish	Nickel, Gold	0.005mm		
	Bottom Solder	SM-002	0.025mm	4	
	Stiffener 1	Core-009	0.100mm	4.5	
	Board Layer Stack Bottom Overlay				



Top Layer
Bottom
Top Overlay
Bottom Overlay

